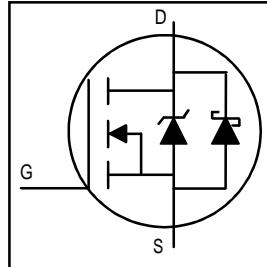


FETKY™ MOSFET & SCHOTTKY RECTIFIER

- Copackaged HEXFET® Power MOSFET and Schottky Diode
- Generation 5 Technology
- Logic Level Gate Drive
- Minimize Circuit Inductance
- Ideal For Synchronous Regulator Application

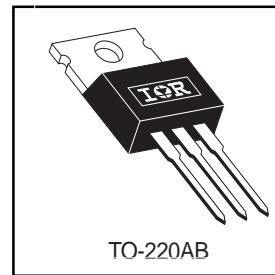


$V_{DSS} = 30V$
 $R_{DS(on)} = 0.014\Omega$
 $I_D = 64A$

Description

The FETKY family of copackaged HEXFET power MOSFETs and Schottky Diodes offer the designer an innovative board space saving solution for switching regulator applications. A low on resistance Gen 5 MOSFET with a low forward voltage drop Schottky diode and minimized component interconnect inductance and resistance result in maximized converter efficiencies.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



Absolute Maximum Ratings

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$ ③	64	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$ ③	45	
I_{DM}	Pulsed Drain Current ①③	220	
$P_D @ T_A = 25^\circ C$	Power Dissipation	2.0	W
$P_D @ T_C = 25^\circ C$	Power Dissipation	89	W
	Linear Derating Factor	0.56	W/°C
V_{GS}	Gate-to-Source Voltage	± 16	V
T_J	Operating Junction and	-55 to + 150	°C
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	°C
	Mounting torque, 6-32 or M3 screw	10 lbf·in (1.1N·m)	

Thermal Resistance

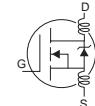
	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	1.4	°C/W
$R_{\theta JA}$	Junction-to-Ambient	—	62	

IRL3103D1

International
Rectifier

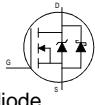
MOSFET Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	30	—	—	V	$V_{\text{GS}} = 0\text{V}$, $I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	—	0.037	—	V°C	Reference to 25°C , $I_D = 1\text{mA}$ ④
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	—	—	0.014	Ω	$V_{\text{GS}} = 10\text{V}$, $I_D = 34\text{A}$ ②
		—	—	0.019		$V_{\text{GS}} = 4.5\text{V}$, $I_D = 28\text{A}$ ②
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	1.0	—	—	V	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = 250\mu\text{A}$
g_{fs}	Forward Transconductance	23	—	—	S	$V_{\text{DS}} = 25\text{V}$, $I_D = 32\text{A}$ ③
I_{DSS}	Drain-to-Source Leakage Current	—	—	0.10	mA	$V_{\text{DS}} = 30\text{V}$, $V_{\text{GS}} = 0\text{V}$
		—	—	22		$V_{\text{DS}} = 24\text{V}$, $V_{\text{GS}} = 0\text{V}$, $T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{\text{GS}} = 16\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{\text{GS}} = -16\text{V}$
Q_g	Total Gate Charge	—	—	43	nC	$I_D = 32\text{A}$
Q_{gs}	Gate-to-Source Charge	—	—	14		$V_{\text{DS}} = 24\text{V}$
Q_{gd}	Gate-to-Drain ("Miller") Charge	—	—	23		$V_{\text{GS}} = 4.5\text{V}$, See Fig. 6 ②
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	9.0	—	ns	$V_{\text{DD}} = 15\text{V}$
t_r	Rise Time	—	210	—		$I_D = 32\text{A}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	20	—		$R_G = 3.4\Omega$, $V_{\text{GS}} = 4.5\text{V}$
t_f	Fall Time	—	54	—		$R_D = 0.43\ \Omega$, ②③
L_D	Internal Drain Inductance	—	4.5	—	nH	Between lead, 6mm (0.25in.)
L_S	Internal Source Inductance	—	7.5	—		from package and center of die contact
C_{iss}	Input Capacitance	—	1900	—	pF	$V_{\text{GS}} = 0\text{V}$
C_{oss}	Output Capacitance	—	810	—		$V_{\text{DS}} = 25\text{V}$
C_{rss}	Reverse Transfer Capacitance	—	240	—		$f = 1.0\text{MHz}$, See Fig. 5
C_{iss}	Input Capacitance	—	3500	—		$V_{\text{GS}} = 0\text{V}$, $V_{\text{DS}} = 0\text{V}$



Body Diode & Schottky Diode Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_F (AV)	(Schottky)	—	—	2.0	A	MOSFET symbol showing the integral reverse p-n junction and Schottky diode.
	Pulsed Source Current (Body Diode) ①	—	—	220		
$V_{\text{SD}1}$	Diode Forward Voltage	—	—	1.3	V	$T_J = 25^\circ\text{C}$, $I_S = 32\text{A}$, $V_{\text{GS}} = 0\text{V}$ ②
$V_{\text{SD}2}$	Diode Forward Voltage	—	—	0.50	V	$T_J = 25^\circ\text{C}$, $I_S = 1.0\text{A}$, $V_{\text{GS}} = 0\text{V}$ ②
t_{rr}	Reverse Recovery Time	—	51	77	ns	$T_J = 25^\circ\text{C}$, $I_F = 32\text{A}$
Q_{rr}	Reverse Recovery Charge	—	49	73	nC	$di/dt = 100\text{A}/\mu\text{s}$ ②
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				



Notes:

① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 10)

③ Uses IRL3103 data and test conditions

② Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.

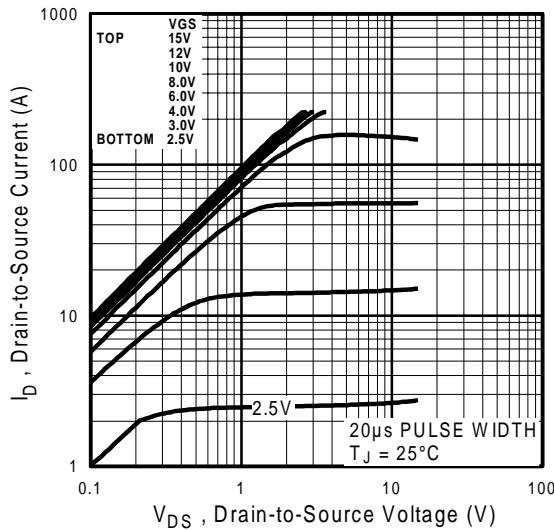


Fig 1. Typical Output Characteristics

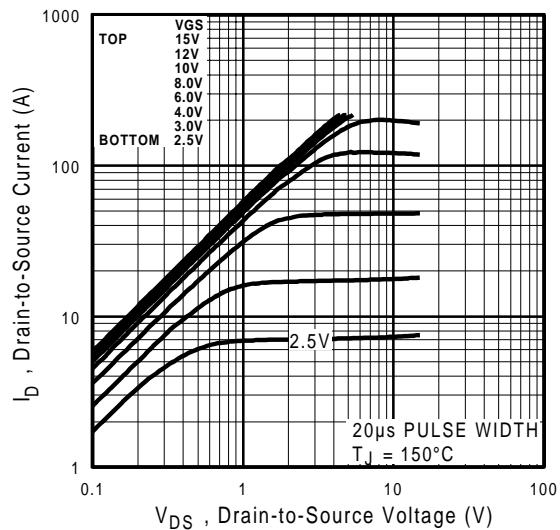


Fig 2. Typical Output Characteristics

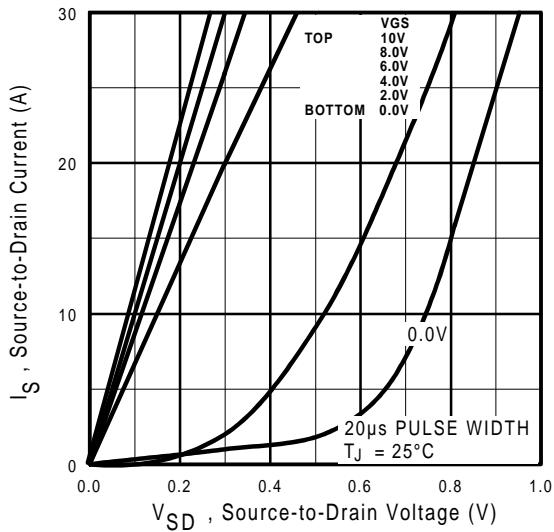


Fig 3. Typical Reverse Output Characteristics

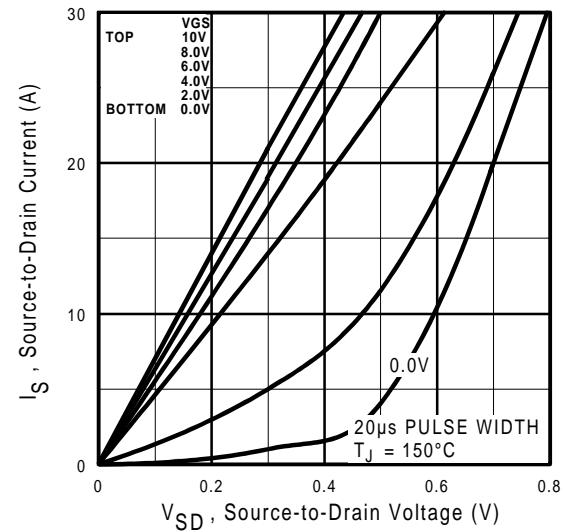


Fig 4. Typical Reverse Output Characteristics

IRL3103D1

International
IR Rectifier

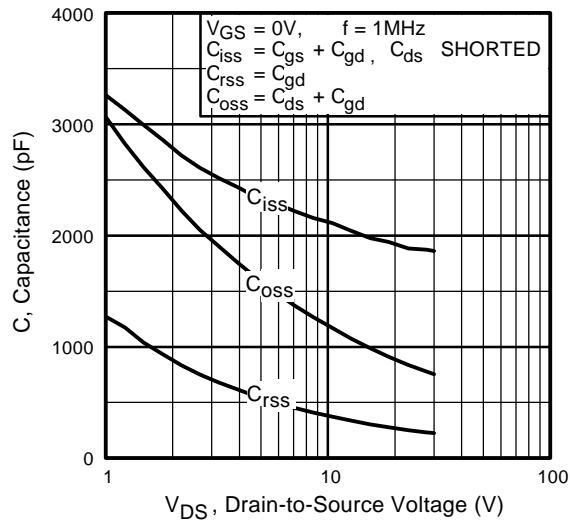


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

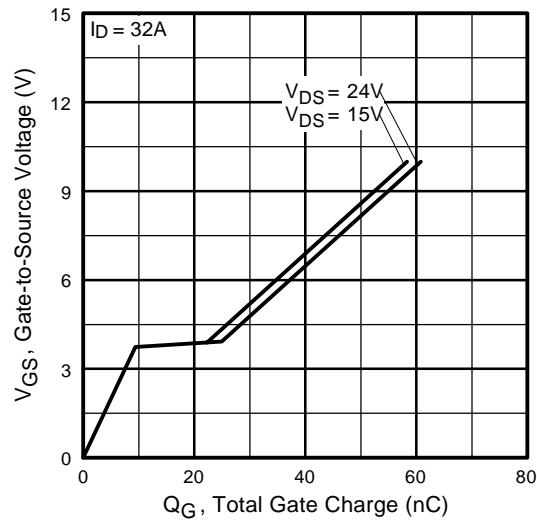


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

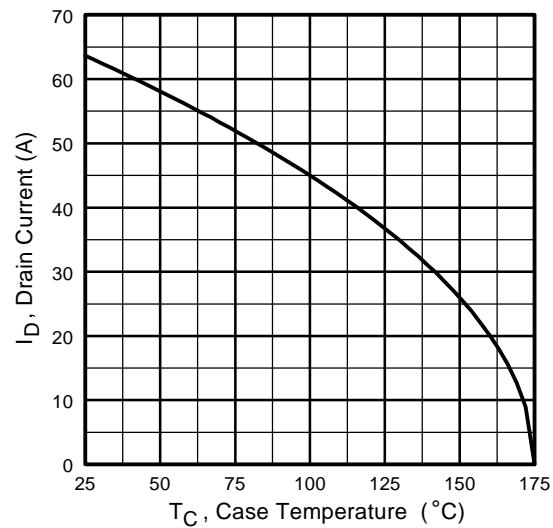


Fig 7. Maximum Drain Current Vs.
Case Temperature

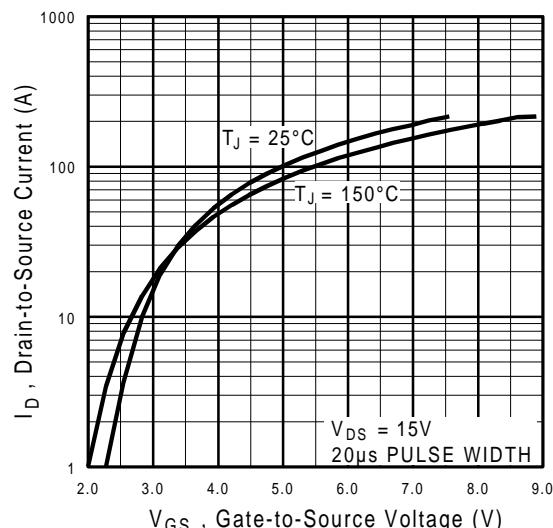


Fig 8. Typical Transfer Characteristics

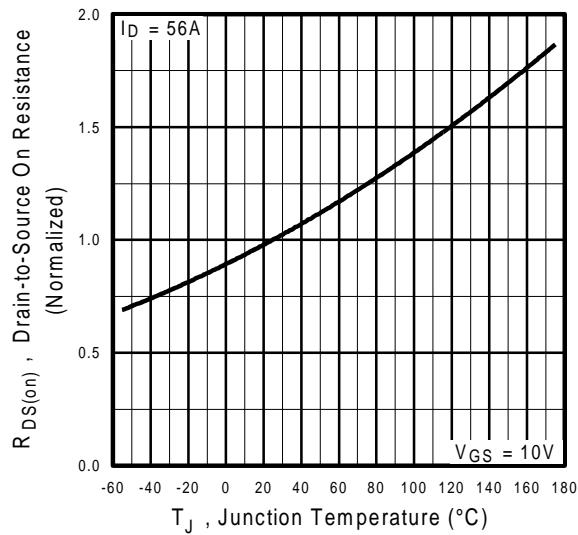


Fig 9. Normalized On-Resistance
Vs. Temperature

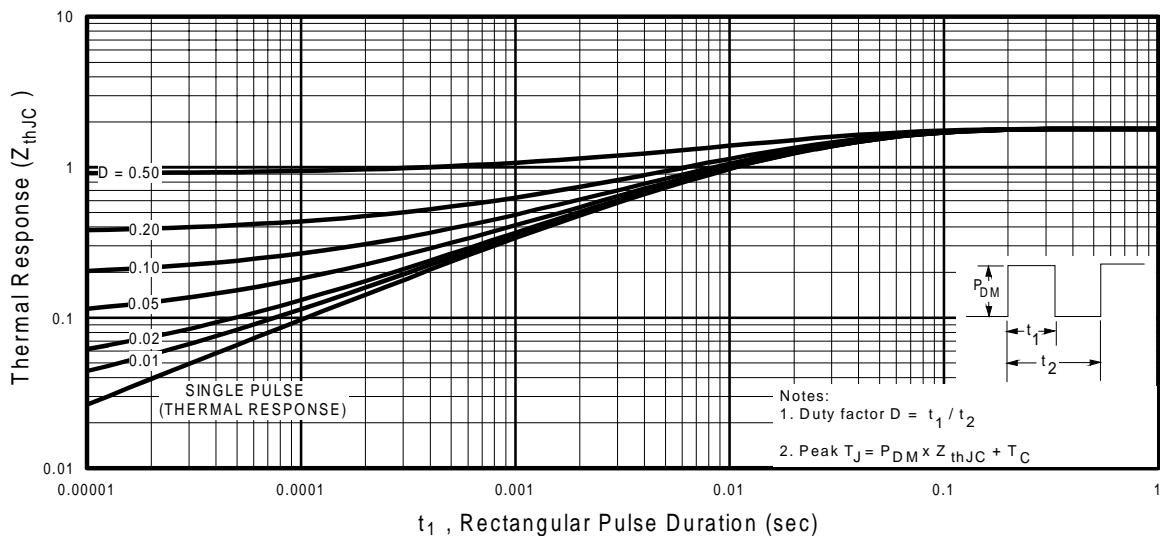


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Case

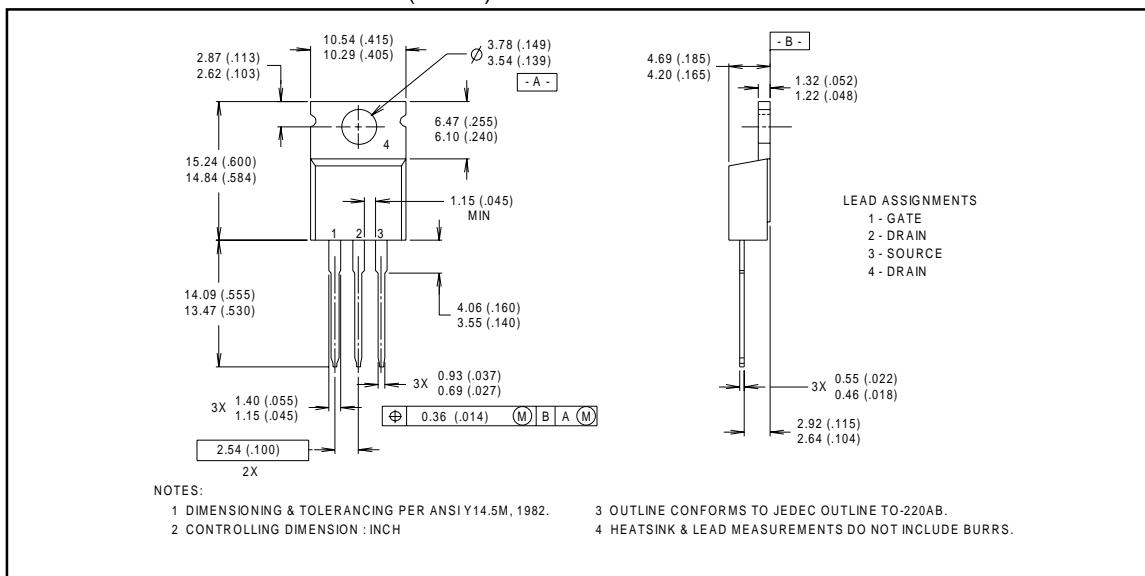
IRL3103D1

International
IR Rectifier

Package Outline

TO-220AB Outline

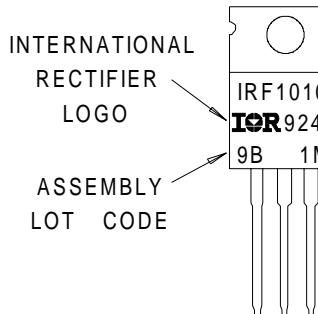
Dimensions are shown in millimeters (inches)



Part Marking Information

TO-220AB

EXAMPLE : THIS IS AN IRF1010
WITH ASSEMBLY
LOT CODE 9B1M



DATE CODE
(YYWW)
YY = YEAR
WW = WEEK

International **TO&R** Rectifier

WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, Tel: (310) 322 3331
EUROPEAN HEADQUARTERS: Hurst Green, Oxted, Surrey RH8 9BB, UK Tel: ++ 44 1883 732020

EUROPEAN HEADQUARTERS: Hurst Green, Oxley, Cirencester GL7 5BB, UK Tel: +44 1453 732893
IR CANADA: 7321 Victoria Park Ave., Suite 201, Markham, Ontario L3R 2Z8, Tel: (905) 475-1897

IR CANADA: 1521 VICTORIA PARK AVE., SUITE 201, MARKHAM, ONTARIO L3R 2Z5, TEL: (905) 473-1551.

IR GERMANY: Saalburgstrasse 157, D-6135 Bad Nauheim Tel: +49 6172 58550
IR ITALY: Via Liguria 48, 10071 Borgaro Torino Tel: +39 11 451 0111

IRITALY. via Liguria 49, 10071 Borgaro, Torino Tel. +39 11 43100111
Ikobukuro 3 Chome, Toshima Ku, Tokyo, Japan 171 Tel: 81 3 3983 0086

IR FAR EAST: K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo Japan 171 Tel: 81 3 3983 0086
IR SOUTHEAST ASIA: 1550 Outram Road, #10-02 Tan Beech List Building, Singapore 2316 Tel: 65 221 8271

IR SOUTHEAST ASIA: 315 Outram Road, #10-02 Ian Boon Liat Building, Singapore 0316 Tel: 65 221 8371
<http://www.ifc.com/> Data and specifications subject to change without notice. 12/2001

<http://www.iit.com/> Data and specifications subject to change without notice. 12/97